

HSF

NOTES:

- 1.Current Rating:2A Max (only one pin) ;
- 2.Voltage Rating:175V DC;
- 3.Contact Resistance:30mΩ Max;
- 4.Withstand Voltage:675V AC;
- 5.Insulation Resistance:5000MΩ Min;
- 6.Operating Temperature: -55°C to +125°C;
- 7.Insulator Material: LCP,G.F,UL94V-0,BK;
- 8.Contact Material:Copper Alloy;
- 9.Contact plating:
 Au on contact area (See ordering information),
 100μ" Matte TIN on solder area,
 50μ" Nickel underplating overall;
- 10.Recommended process:
 Reflow,Peak temperature:260±5°C, 10s ;

Ordering Information

37 2 0 X- P M XX0 OXX XX X XX

OPTIONS

- 1=A
- 2=LC
- 3=FL
- P=PLUG
- M=180° SMT

No OF POSITIONS

- 040=40PIN
- 080=80PIN
- 120=120PIN
- 160=160PIN
- 200=200PIN

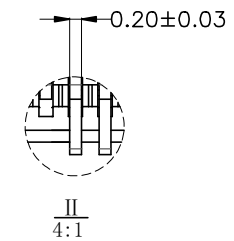
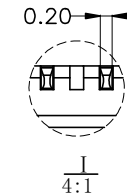
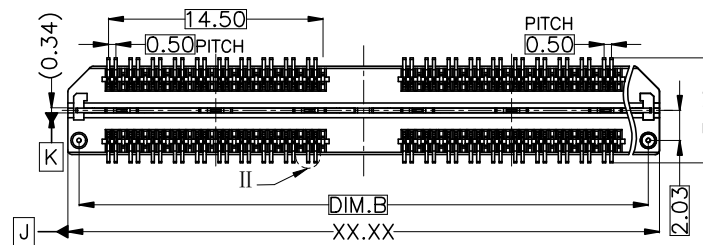
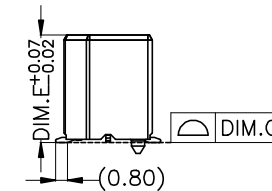
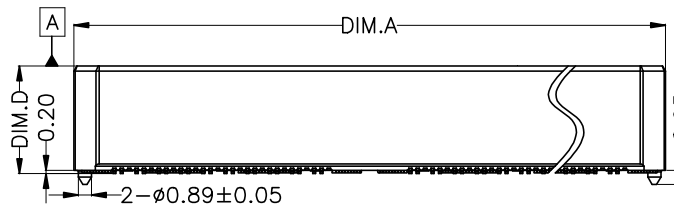
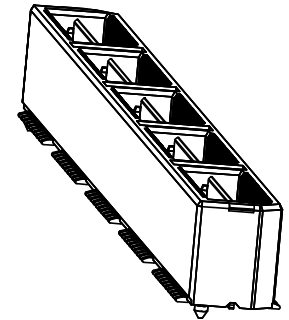
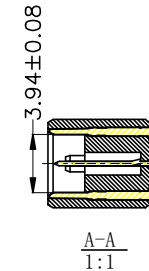
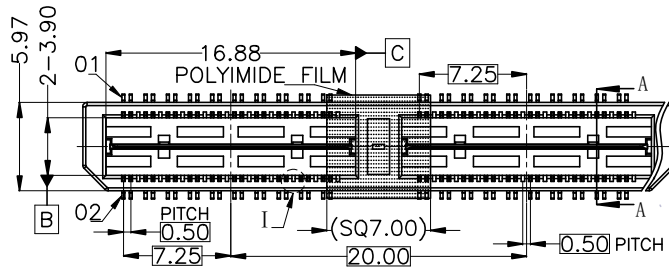
LEAD STYLE

- 042=4.26
- 072=7.26

PLATING

- W1=SEL.3U"GOLD/MATTE SN
- W3=SEL.10U"GOLD/MATTE SN
- W5=SEL.30U"GOLD/MATTE SN

- WCON INTERNAL CODE
- PACKAGING
 A=VACUUM BOX
 R=TAPE&REEL



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	Fit	PART NO.
A1	2022.12.21	ANNOTATION MODE CHANGE	Abt Chen	x.x ±0.40	Abt Chen	2022.04.06	UNIT	mm	RH-37201-PMXXX-042XXX11
A0	2022.04.06	NEW		x.xx ±0.25	CHECK	DATE	SIZE	A4	TITLE: 0.5mmB0 TO B0 PLUG SMT, ASSEMBLY
				x.xxx ±0.15	APPROVE	DATE	SHEET	1/4	Customer NO.
				Angle ± 3°			PROJ.		
				DIM TOL					



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